Part Number: XLMDKCBD34M

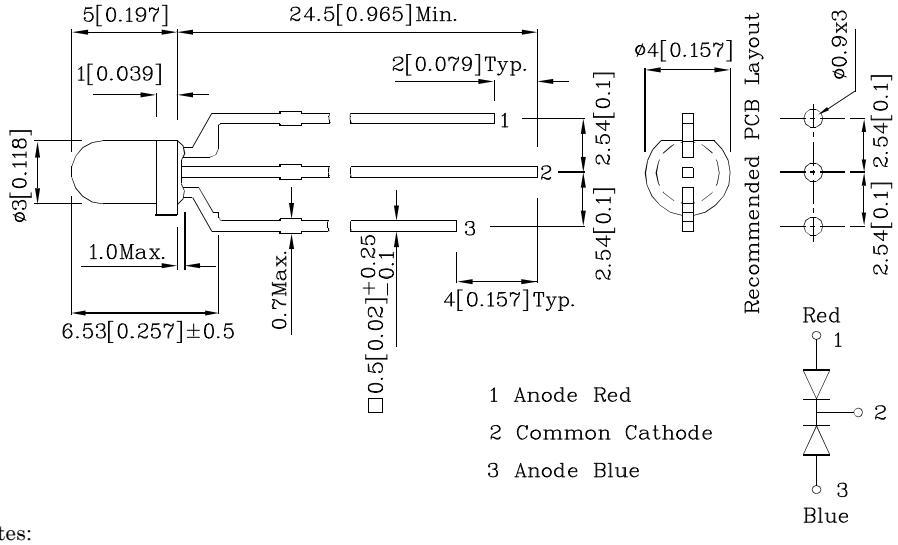
T-1(3mm) BI-COLOR INDICATOR LAMP

Features

- Radial / Through hole package
- Reliable & robust
- Low power consumption
- Available on tape and reel
- RoHS compliant

ATTENTION
OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

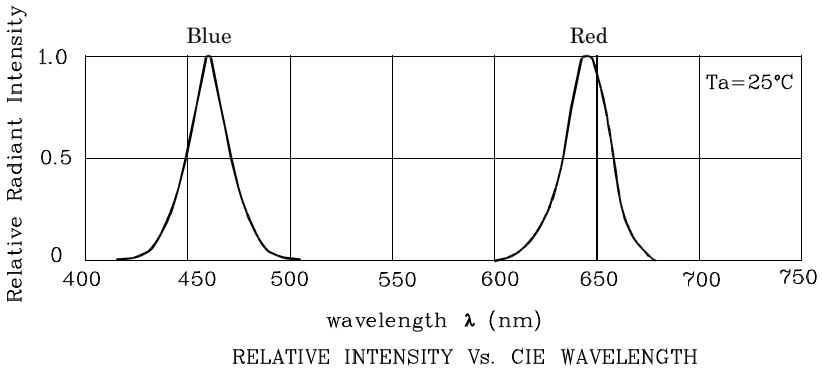
Absolute Maximum Ratings (T_A=25°C)		**Red (AlGaInP)**	**Blue (InGaN)**	**Unit**
Reverse Voltage	V_R	5	5	V
Forward Current	I_F	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	185	150	mA
Power Dissipation	P_D	75	120	mW
Operating Temperature	T_A	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)		3000	250	V
Lead Solder Temperature [2mm Below Package Base]		260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]		260°C For 5 Seconds		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

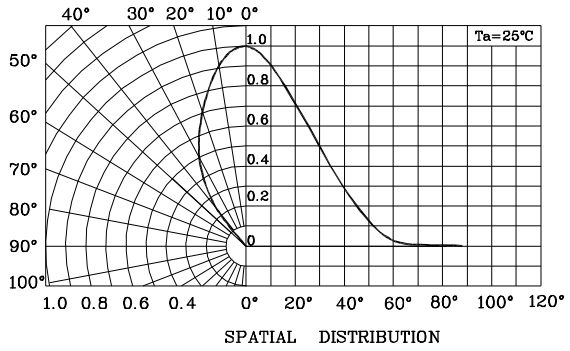
Operating Characteristics (T_A=25°C)		**Red (AlGaInP)**	**Blue (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	1.95	3.3	V
Forward Voltage (Max.) (I_F=20mA)	V_F	2.5	4	V
Reverse Current (Max.) (V_R=5V)	I_R	10	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I_F=20mA)	λP	645*	460*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I_F=20mA)	λD	630*	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	△λ	28	25	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	35	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I_F=20mA) mcd min.	Luminous Intensity CIE127-2007* (I_F=20mA) mcd typ.	Wavelength CIE127-2007* nm λP	Viewing Angle 2θ 1/2
XLMDKCBD34M	Red	AlGaInP	White Diffused	400 80*	695 158*	645*	60°
	Blue	InGaN		100 100*	198 198*	460*	

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

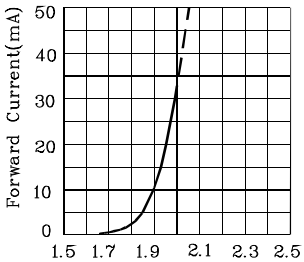


RELATIVE INTENSITY Vs. CIE WAVELENGTH

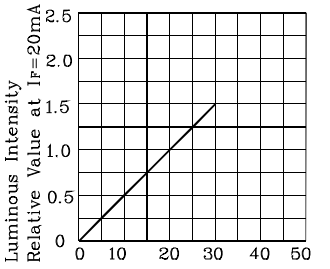


SPATIAL DISTRIBUTION

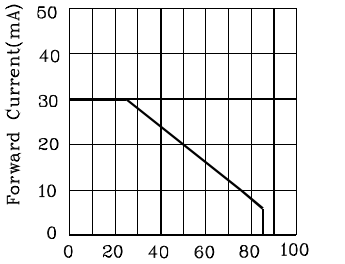
❖ Red



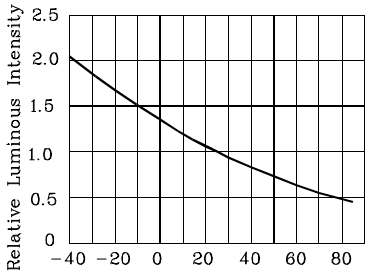
FORWARD CURRENT Vs. FORWARD VOLTAGE



LUMINOUS INTENSITY Vs. FORWARD CURRENT

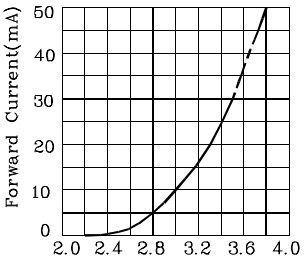


FORWARD CURRENT DERATING CURVE

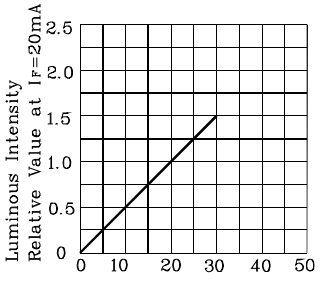


LUMINOUS INTENSITY Vs. AMBIENT TEMPERATURE

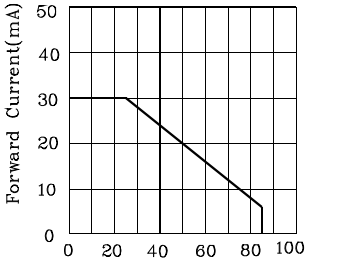
❖ Blue



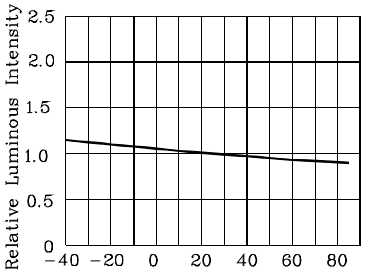
FORWARD CURRENT Vs. FORWARD VOLTAGE



LUMINOUS INTENSITY Vs. FORWARD CURRENT

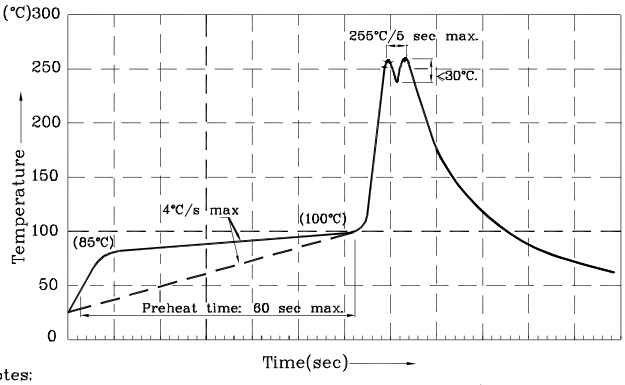


FORWARD CURRENT DERATING CURVE



LUMINOUS INTENSITY Vs. AMBIENT TEMPERATURE

Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



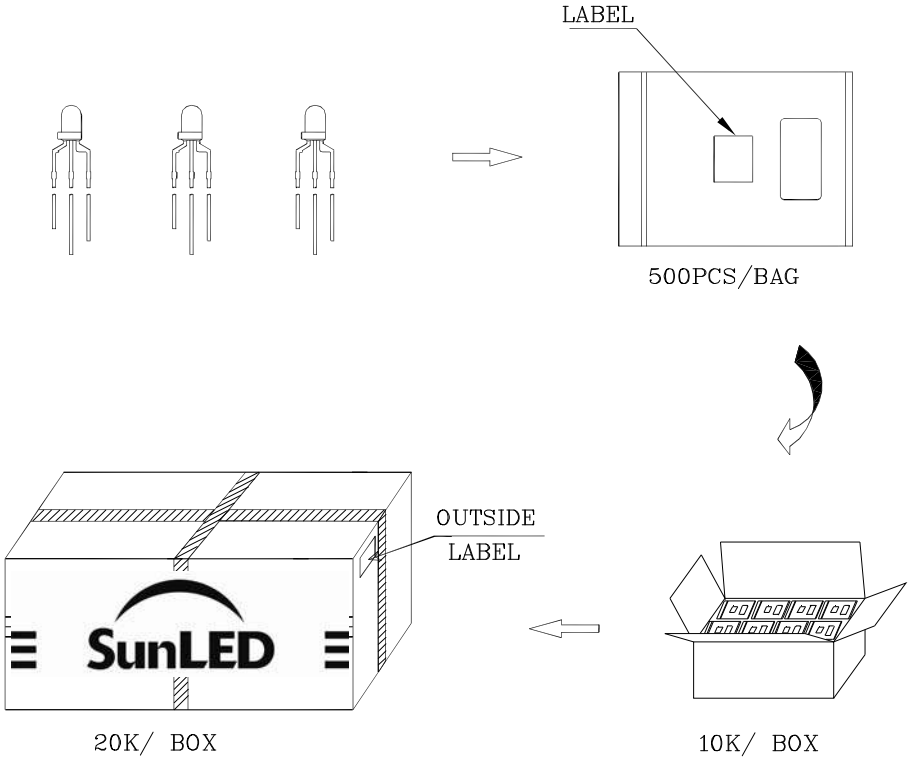
Notes:
1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

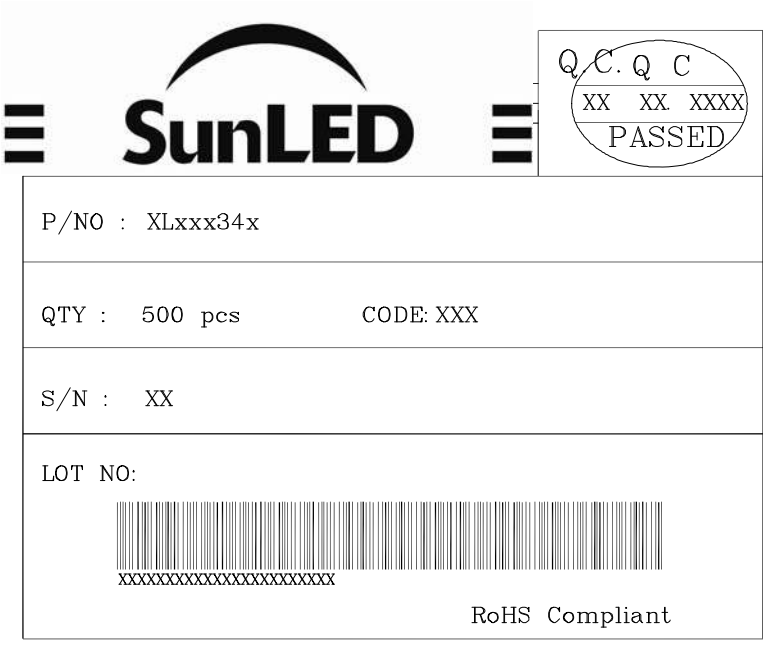
Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),
the typical accuracy of the sorting process is as follows:
1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS





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